Low-ohmic single-pole double-throw analog switch

Rev. 6.2 — 3 December 2019

Product data sheet

1. General description

The NX3L1T5157 is a low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2:1 multiplexer/demultiplexer. It has a digital select input (S), two independent inputs/outputs (Y0 and Y1) and a common input/output (Z).

Schmitt trigger action at the digital input makes the circuit tolerant to slower input rise and fall times. Low threshold digital input allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L1T5157 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L1T5157 allows signals with amplitude up to V_{CC} to be transmitted from Z to Y0 or Y1, or from Y0 or Y1 to Z. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.6 Ω (typical) at V_{CC} = 1.4 V
 - 1.0 Ω (typical) at V_{CC} = 1.65 V
 - 0.55 Ω (typical) at V_{CC} = 2.3 V
 - 0.50 Ω (typical) at V_{CC} = 2.7 V
 - 0.50 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD78 Class II Level A
- 1.8 V control logic at V_{CC} = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

Table 1. Ordering information

Type number							
	marking ^[1]	Name	Description	Version			
NX3L1T5157GM	DI	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm	SOT886			

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

4.1 Ordering options

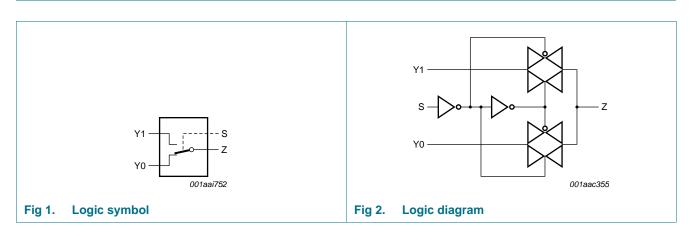
Table 2.Ordering options

Type number	Orderable part number	Package	J	Minimum order quantity	Temperature
NX3L1T5157GM	NX3L1T5157GM,115[1]	XSON6	REEL 7" Q1 NDP	5000	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$
NX3L1T5157GM	NX3L1T5157GM,132[1]	XSON6	REEL 7" Q3 NDP	5000	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$
NX3L1T5157GM	NX3L1T5157GMZ	XSON6	REEL 7" Q1 NDP SSB ^[2]	5000	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$
NX3L1T5157GM	NX3L1T5157GMAZ	XSON6	REEL 7" Q3 NDP SSB ^[2]	5000	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$

 $\begin{tabular}{ll} [1] & \end{tabular} Will go EOL - migrate to new leadframe orderable part number. \end{tabular}$

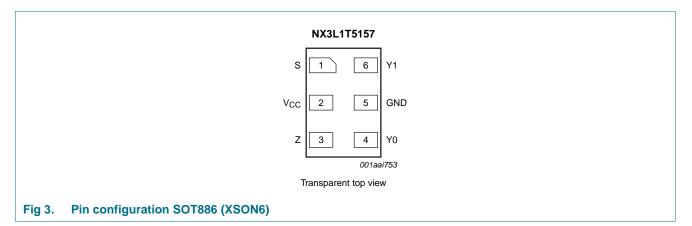
[2] This packing method uses a Static Shielding Bag (SSB) solution. Material is to be kept in the sealed bag between uses.

5. Functional diagram



6. **Pinning information**

6.1 Pinning



6.2 Pin description

Table 3.	Pin descripti	ion
Symbol	Pin	Description
S	1	select input
V _{CC}	2	supply voltage
Z	3	common input or output
Y0	4	independent input or output
GND	5	ground (0 V)
Y1	6	independent input or output

7. Functional description

Function table^[1] Table 4.

Input S	Channel on
L	Y0
Н	Y1

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
VI	input voltage	select input S	<u>[1]</u>	-0.5	+4.6	V
V _{SW}	switch voltage		[2]	-0.5	V _{CC} + 0.5	V
l _{IK}	input clamping current	V _I < -0.5 V		-50	-	mA
I _{SK}	switch clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V		-	±50	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current		-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current		-	±500	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3]	-	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XSON6 package: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.4	4.3	V
VI	input voltage	select input S	0	4.3	V
V _{SW}	switch voltage	[1]	0	V _{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 1.4 V to 4.3 V [2]	-	200	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

10. Static characteristics

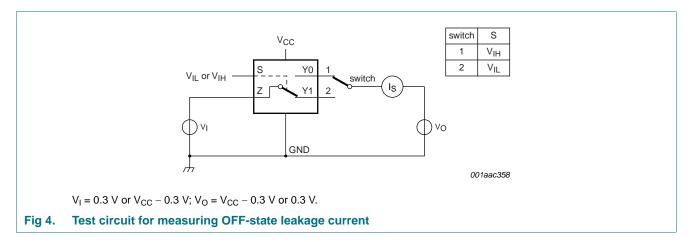
Table 7. Static characteristics

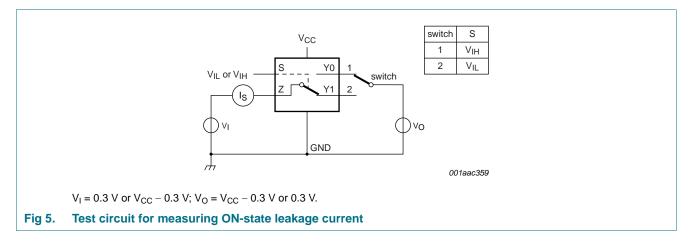
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	T,	_{amb} = 25	°C	T _{amb} = −40 °C to +125 °C			Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V _{IH}	HIGH-level	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	0.9	-	-	0.9	-	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		V _{CC} = 2.7 V to 3.6 V	1.3	-	-	1.3	-	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	1.4	-	-	1.4	-	-	V
V _{IL}	LOW-level	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	-	0.3	-	0.3	0.3	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
I	input leakage current	select input S; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μA
I _{S(OFF)}	F) OFF-state leakage	Y0 and Y1 port; see <u>Figure 4</u>							
	current	V _{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nA
I _{S(ON)}	ON-state	Z port; see Figure 5							
	leakage	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
	current	$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC}							
		V _{CC} = 3.6 V	-	-	100	-	690	6000	nA
		V _{CC} = 4.3 V	-	-	150	-	800	7000	nA
Δl _{CC}	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μΑ
		V _I = 2.6 V; V _{CC} = 3.6 V	-	0.35	0.7	-	1	1	μΑ
		$V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	7.0	10.0	-	15	15	μΑ
		V _I = 1.8 V; V _{CC} = 3.6 V	-	2.5	4.0	-	5	5	μΑ
		V _I = 1.8 V; V _{CC} = 2.5 V	-	50	200	-	300	500	nA
CI	input capacitance		-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	130	-	-	-	-	pF

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10.1 Test circuits





10.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see <u>Figure 7</u> to <u>Figure 13</u>.

Symbol	Parameter	Conditions	T _{amb} =	T_{amb} = –40 °C to +85 °C		$T_{amb} = -40 \circ 0$	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA; see Figure 6						
		V _{CC} = 1.4 V	-	1.6	3.7	-	4.1	Ω
		V _{CC} = 1.65 V	-	1.0	1.6	-	1.7	Ω
		V _{CC} = 2.3 V	-	0.55	0.8	-	0.9	Ω
		V _{CC} = 2.7 V	-	0.5	0.75	-	0.9	Ω
		V _{CC} = 4.3 V	-	0.5	0.75	-	0.9	Ω

Table 8. ON resistance ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 7 to Figure 13.

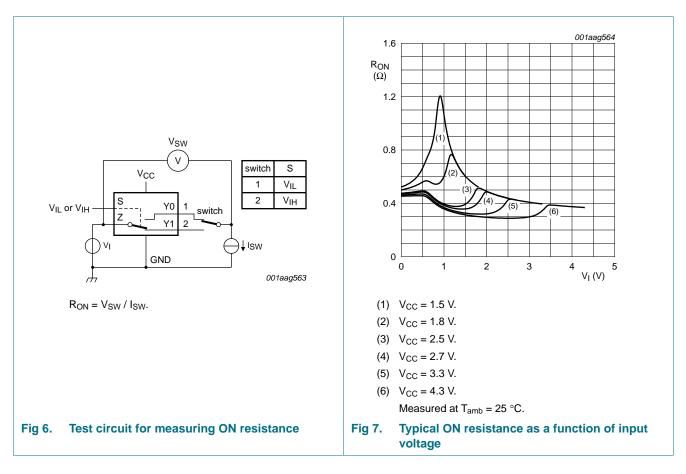
Symbol	Parameter	Conditions	T _{amb} =	-40 °C to	o +85 °C	T_{amb} = -40 °	C to +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
ΔR _{ON} ON resistance mismatch		$V_{I} = GND \text{ to } V_{CC}; \qquad [2]$ $I_{SW} = 100 \text{ mA}$						
	between channels	V _{CC} = 1.4 V	-	0.04	0.3	-	0.3	Ω
	Charmeis	V _{CC} = 1.65 V	-	0.04	0.2	-	0.3	Ω
		V _{CC} = 2.3 V	-	0.02	0.08	-	0.1	Ω
		$V_{CC} = 2.7 V$	-	0.02	0.075	-	0.1	Ω
		$V_{CC} = 4.3 V$	-	0.02	0.075	-	0.1	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_{I} = GND \text{ to } V_{CC}; \qquad [3]$ $I_{SW} = 100 \text{ mA}$						
		V _{CC} = 1.4 V	-	1.0	3.3	-	3.6	Ω
		V _{CC} = 1.65 V	-	0.5	1.2	-	1.3	Ω
		V _{CC} = 2.3 V	-	0.15	0.3	-	0.35	Ω
		V _{CC} = 2.7 V	-	0.13	0.3	-	0.35	Ω
		V _{CC} = 4.3 V	-	0.2	0.4	-	0.45	Ω

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$.

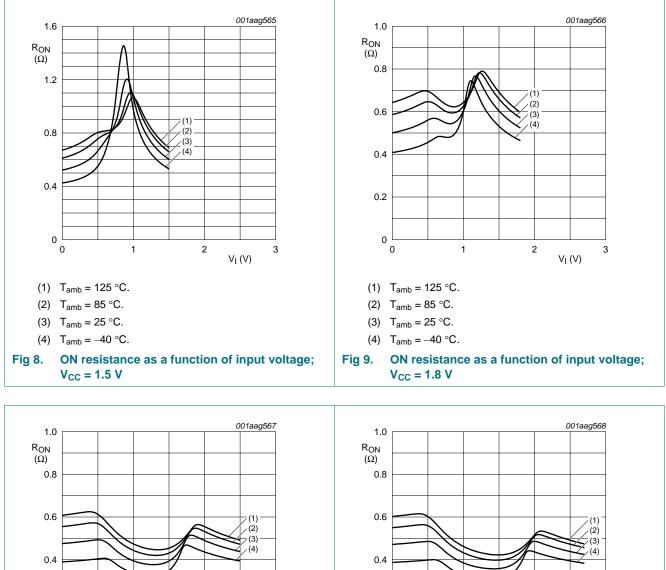
[2] Measured at identical V_{CC}, temperature and input voltage.

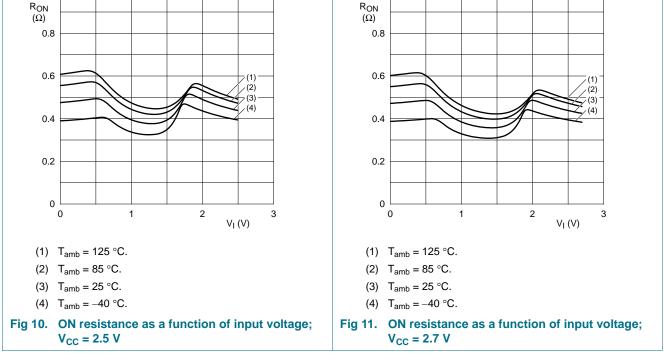
[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

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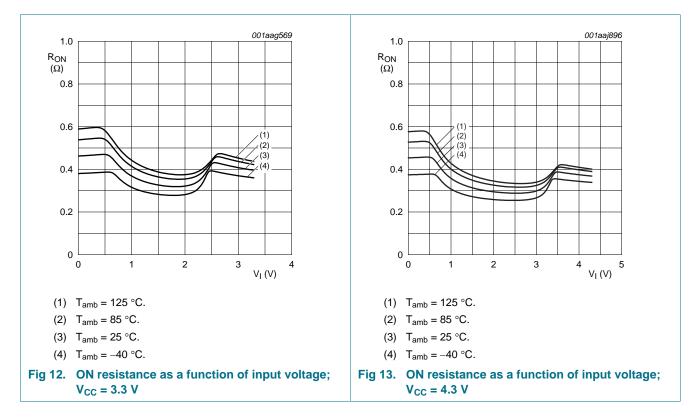


10.3 ON resistance test circuit and graphs





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11. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

Symbol	Parameter	Conditions		25 °C		–40 °C to +125 °C			Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Мах (85 °С)	Max (125 °C)	
t _{en}	enable time	S to Z or Yn; see Figure 14							
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	50	90	-	120	120	ns
		V _{CC} = 1.65 V to 1.95 V	-	36	70	-	80	90	ns
		V_{CC} = 2.3 V to 2.7 V	-	24	45	-	50	55	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	22	40	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V	-	22	40	-	45	50	ns
t _{dis}	disable time	S to Z or Yn; see Figure 14							
		V_{CC} = 1.4 V to 1.6 V	-	32	70	-	80	90	ns
		V_{CC} = 1.65 V to 1.95 V	-	20	55	-	60	65	ns
		V_{CC} = 2.3 V to 2.7 V	-	12	25	-	30	35	ns
		V_{CC} = 2.7 V to 3.6 V	-	10	20	-	25	30	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	10	20	-	25	30	ns

Table 9. Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

Symbol	Parameter	Conditions		25 °C		–40 °C to +125 °C		5 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
t _{b-m}	break-before-make	see Figure 15 [2]							
	time	V _{CC} = 1.4 V to 1.6 V	-	19	-	9	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V	-	13	-	4	-	-	ns
		V_{CC} = 2.7 V to 3.6 V	-	10	-	3	-	-	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	10	-	2	-	-	ns

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

11.1 Waveform and test circuits

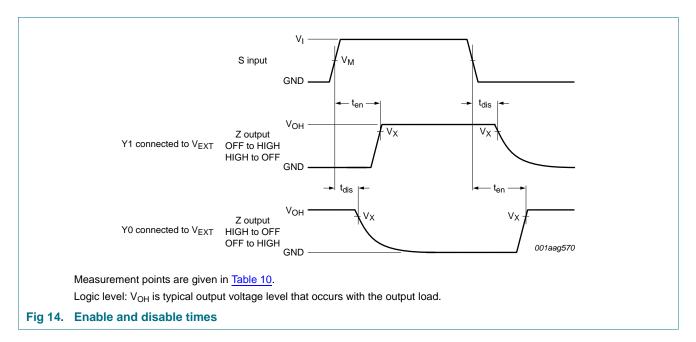
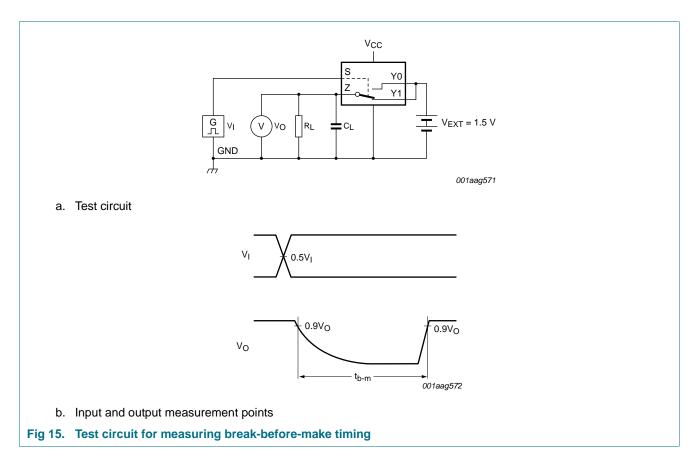


Table 10.Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _x
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}

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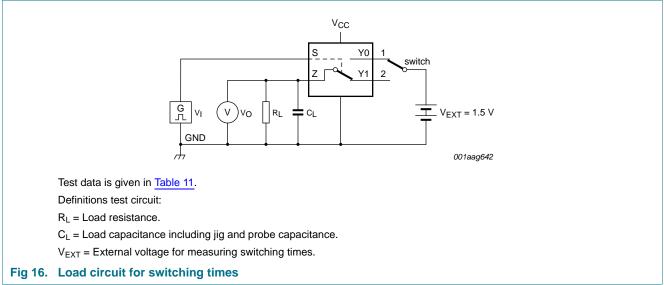


Table 11. Test data

Supply voltage	Input		Load		
V _{cc}	VI	t _r , t _f	CL	RL	
1.4 V to 4.3 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω	

NX3L1T5157

11.2 Additional dynamic characteristics

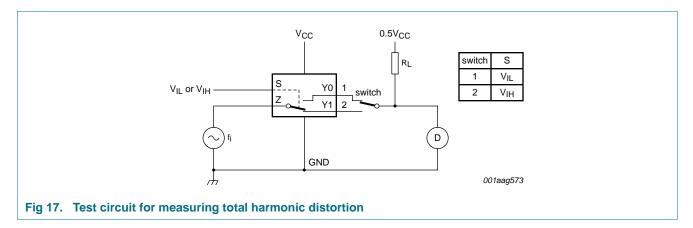
Table 12. Additional dynamic characteristics

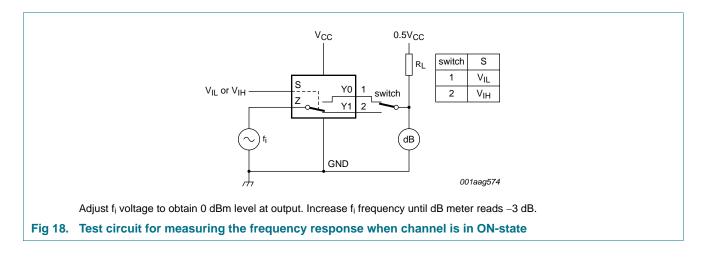
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

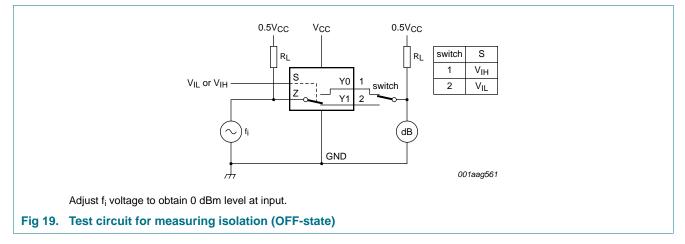
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i = 20$ Hz to 20 kHz; $R_L = 32 \Omega$; see Figure 17	[1]				
		V _{CC} = 1.4 V; V _I = 1 V (p-p)		-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)		-	0.10	-	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)		-	0.02	-	%
		V _{CC} = 2.7 V; V _I = 2 V (p-p)		-	0.02	-	%
		V _{CC} = 4.3 V; V _I = 2 V (p-p)		-	0.02	-	%
f _(-3dB)	-3 dB frequency response	$R_L = 50 \Omega$; see Figure 18	[1]				
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		-	60	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}; R_L = 50 \Omega; \text{ see } Figure 19$	[1]				
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$		-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 20					
		V _{CC} = 1.4 V to 3.6 V		-	0.2	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$		-	0.3	-	V
Q _{inj}	charge injection	$ f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; \\ R_{gen} = 0 \Omega; \text{ see } \underline{Figure \ 21} $					
		V _{CC} = 1.5 V		-	3	-	рС
		V _{CC} = 1.8 V		-	4	-	рС
		V _{CC} = 2.5 V		-	6	-	рС
		V _{CC} = 3.3 V		-	9	-	рС
		$V_{CC} = 4.3 V$		-	15	-	рС
				1			

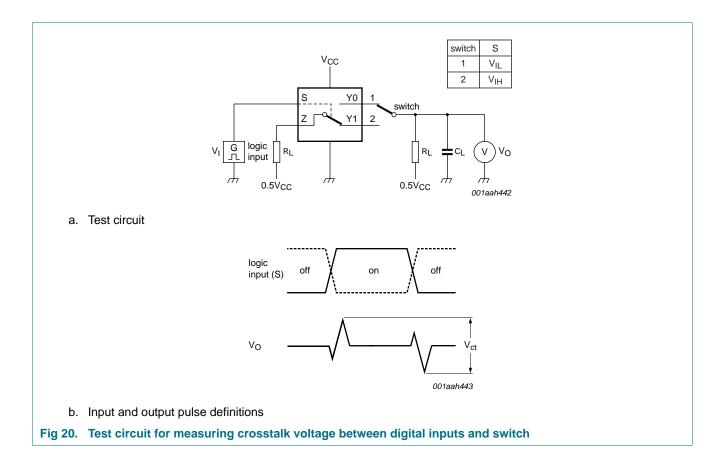
[1] f_i is biased at 0.5V_{CC}.

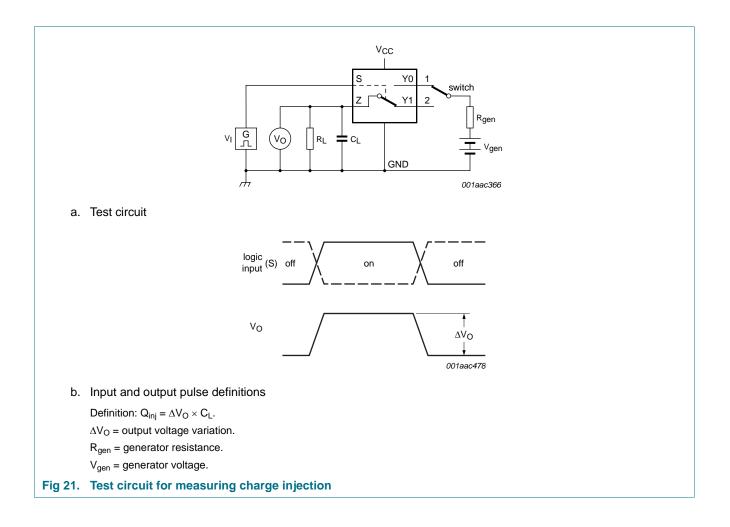
11.3 Test circuits











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12. Package outline

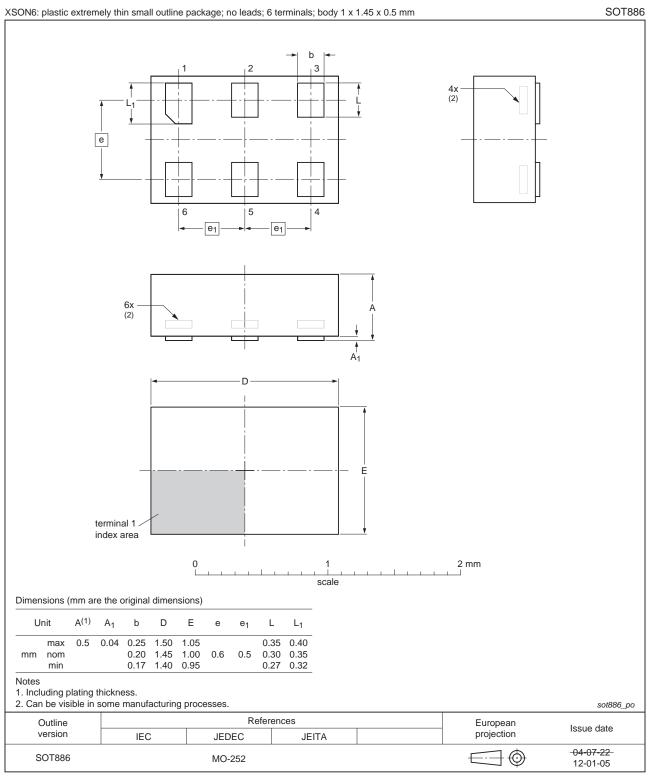


Fig 22. Package outline SOT886 (XSON6)

NX3L1T5157

13. Abbreviations

Table 13. Abbreviations			
Acronym	Description		
CDM	Charged Device Model		
CMOS	Complementary Metal-Oxide Semiconductor		
ESD	ElectroStatic Discharge		
НВМ	Human Body Model		
MM	Machine Model		
PDA	Personal Digital Assistant		

14. Revision history

Table 14.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
NX3L1T5157 v.6.2	20191203	Product data sheet	-	NX3L1T5157 v.6.1		
Modifications:		 Package SOT886 requiring SSB added. Refer to PCN number 201909001 XSON6 (SOT886) Assembly/Test Transfer from ATGD and ATSN to ATBK 				
NX3L1T5157 v.6.1	20161130	Product data sheet	-	NX3L1T5157 v.6		
Modifications:	Added Section	on 13 "Packing information'	, -			
NX3L1T5157 v.6	20111108	Product data sheet	-	NX3L1T5157 v.5		
Modifications:	 Legal pages 	updated.				
NX3L1T5157 v.5	20110728	Product data sheet	-	NX3L1T5157 v.4		
NX3L1T5157 v.4	20100324	Product data sheet	-	NX3L1T5157 v.3		
NX3L1T5157 v.3	20100208	Product data sheet	-	NX3L1T5157 v.2		
NX3L1T5157 v.2	20090417	Product data sheet	-	NX3L1T5157 v.1		
NX3L1T5157 v.1	20080916	Product data sheet	-	-		

15. Legal information

15.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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